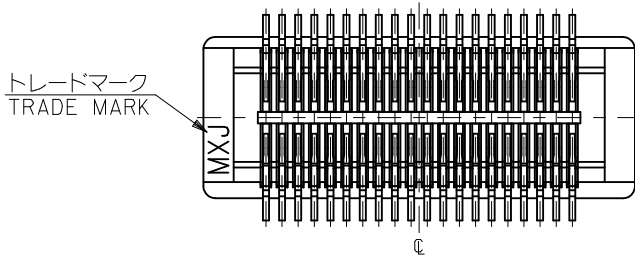


参考基板レイアウト (マウント面)
RECOMMENDED P.C.BOARD
PATTERN DIMENSION (REF.)
(MOUNTING AREA)



注記 NOTES:

1. 使用材料 MATERIAL
ハウジング: 液晶ポリマー ガラス充填 UL94V-0 茶色
HOUSING: LIQUID CRYSTAL POLYMER
GLASS FILLED UL94V-0
COLOR BROWN
ターミナル: リン青銅 (t=0.15)
TERMINAL: PHOSPHOR BRONZE (t=0.15)
2. メッキ仕様 PLATING
金メッキ 0.25 マイクロメートル以上 (コンタクト部)
GOLD 0.25MICROMETER MINIMUM (CONTACT AREA)
金メッキ 0.4 マイクロメートル以下 (テール部)
GOLD 0.4MICROMETER MAXIMUM (TAIL AREA)
下地メッキ: ニッケルメッキ 1.5 マイクロメートル以上
UNDER PLATING: NICKEL 1.5MICROMETER MINIMUM

3. (全極数/2) = 偶数の場合に適用。
APPLY FOR (CIRCUIT/2)=EVEN.
4. 嵌合相手: 55526.501017 シリーズ
MATE WITH: 55526.501017 SERIES.
5. テール平坦度は、0.10 MAX.
TAIL COPLANARITY TO BE 0.10 MAX.

30.6	29.6	32.7	54684-1507	150
24.6	23.6	26.7	54684-1207	120
12.6	11.6	14.7	54684-0607	60
10.6	9.6	12.7	54684-0507	50
C	B	A	MATERIAL NO.	CIRCUIT
MODEL NO.			54684-***7	

REVISED EC NO: J2010-2046 DRWN: TARA101 2010/04/13 CHKD: YMIZUNO 2010/04/14 APPR: MSASAO 2010/04/16	DESCRIPTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		DIMENSION STYLE MM ONLY		SCALE ---	DESIGN UNITS METRIC	THIRD ANGLE PROJECTION	
		10 UNDER	±0.2	DRAWN BY SAIHARA	DATE 1999/10/02	TITLE 0.4 B-TO-B CONN REC HSG ASSY NO BOSS			
		10 OVER 30 UNDER	±0.25	CHECKED BY YMIZUNO	DATE 2002/03/11	APPROVED BY TYAMAGUCHI 2002/03/11			
		30 OVER	±0.3	MATERIAL NO. SEE TABLE		DOCUMENT NO. SD-54684-003		SHEET NO. 1 OF 1	
ANGULAR ±3 °		DRAFT WHERE APPLICABLE MUST REMAIN WITHIN DIMENSIONS		THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO MOLEX INCORPORATED AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION					